

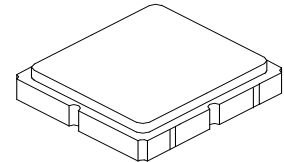
- 440.6 to 457.4 MHz Filter
- Optimized for use with the TRC105 Transceiver
- Balanced 150 ohm IC Interface
- Complies with Directive 2002/95/EC (RoHS)
- Moisture Sensitivity Level: 1

Absolute Maximum Ratings

Rating	Value	Units
Input Power Level	+15	dBm
DC Voltage	±5	V
Operating Temperature Range	-40 to +85	°C
Storage Temperature Range in Tape and Reel	-40 to +85	°C

RF3609D

**449.0 MHz
SAW Filter**



SM3838-8

Electrical Characteristics

Characteristic	Sym	Notes	Min	Typ	Max	Units
Center Frequency	f_C			449.0		MHz
1 dB Bandwidth	BW_1			18.0		MHz
Maximum Insertion Loss, 440.6 to 457.4 MHz	IL_{MAX}			1.4	2.4	dB
Amplitude Ripple, p-p, 440.6 to 457.4 MHz					1.0	
Rejection Referenced to Insertion Loss at 390.0 MHz:						
DC to 429 MHz			32	35		
479 to 549 MHz			32	35		
549 to 949 MHz			37	40		
949 to 1349 MHz			55	60		
1349 to 1749 MHz			62	65		
1749 to 2000 MHz			59	62		
Source Impedance	Z_S			50		Ω
Balanced Load Impedance	Z_L			150		Ω

Case Style	SM3838-8 3.8 x 3.8 mm Nominal Footprint	
Lid Symbolization (Y=year, WW=week, S=shift) dot=pin 1 indicator	892, YWWS	
Standard Reel Quantity	Reel Size 7 Inch	500 Pieces/Reel
	Reel Size 13 Inch	3000 Pieces/Reel

Electrical Connections

Connection	Terminals
Single-ended Port	6
Balanced Port	1, 3
Case Ground	4, 5, 7, 8
No Connection	2

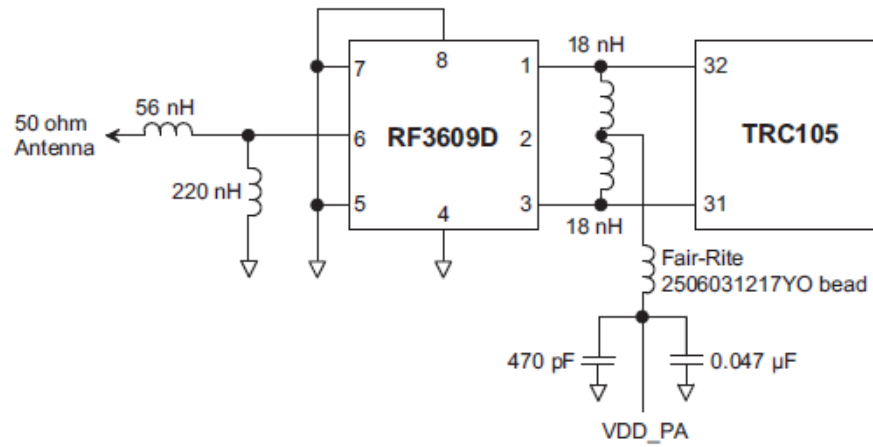


CAUTION: Electrostatic Sensitive Device. Observe precautions for handling.

NOTES:

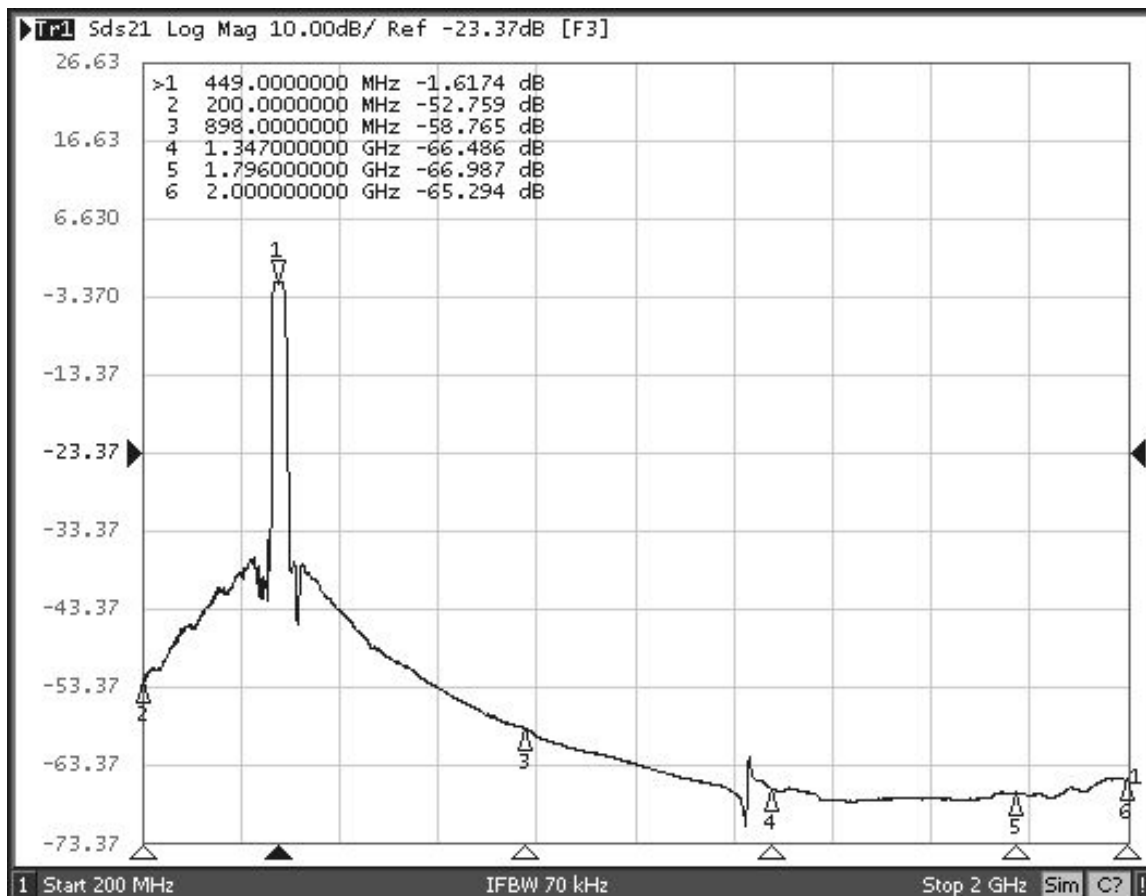
1. The design, manufacturing process, and specifications of this device are subject to change.
2. US or International patents may apply.
3. RoHS compliant from the first date of manufacture.

RF3609D-TRC105 Application Circuit



Reference Circuit Diagram Only
Note: TRC105 has been obsoleted

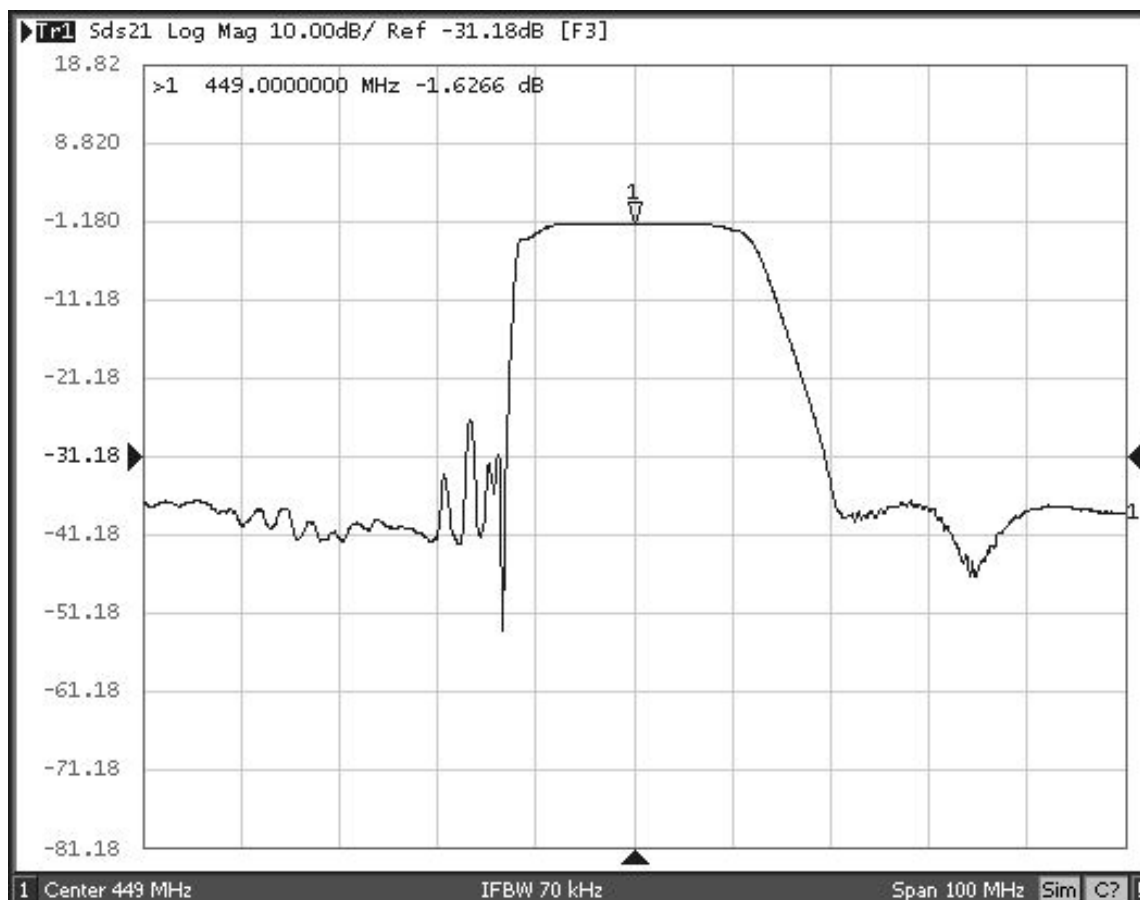
RF3609D Broadband Response, 200 to 2000 MHz



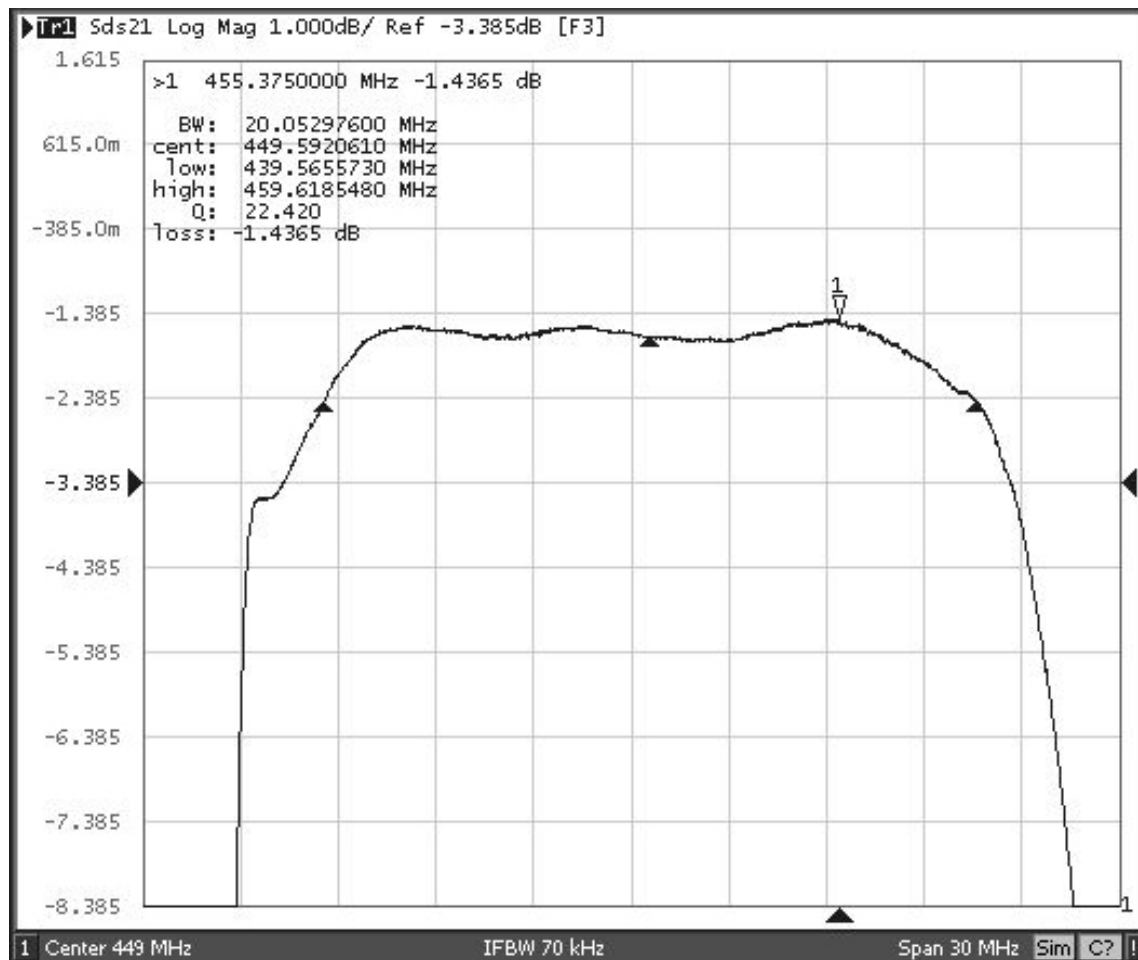
RF3609D Response, 349 to 549 MHz



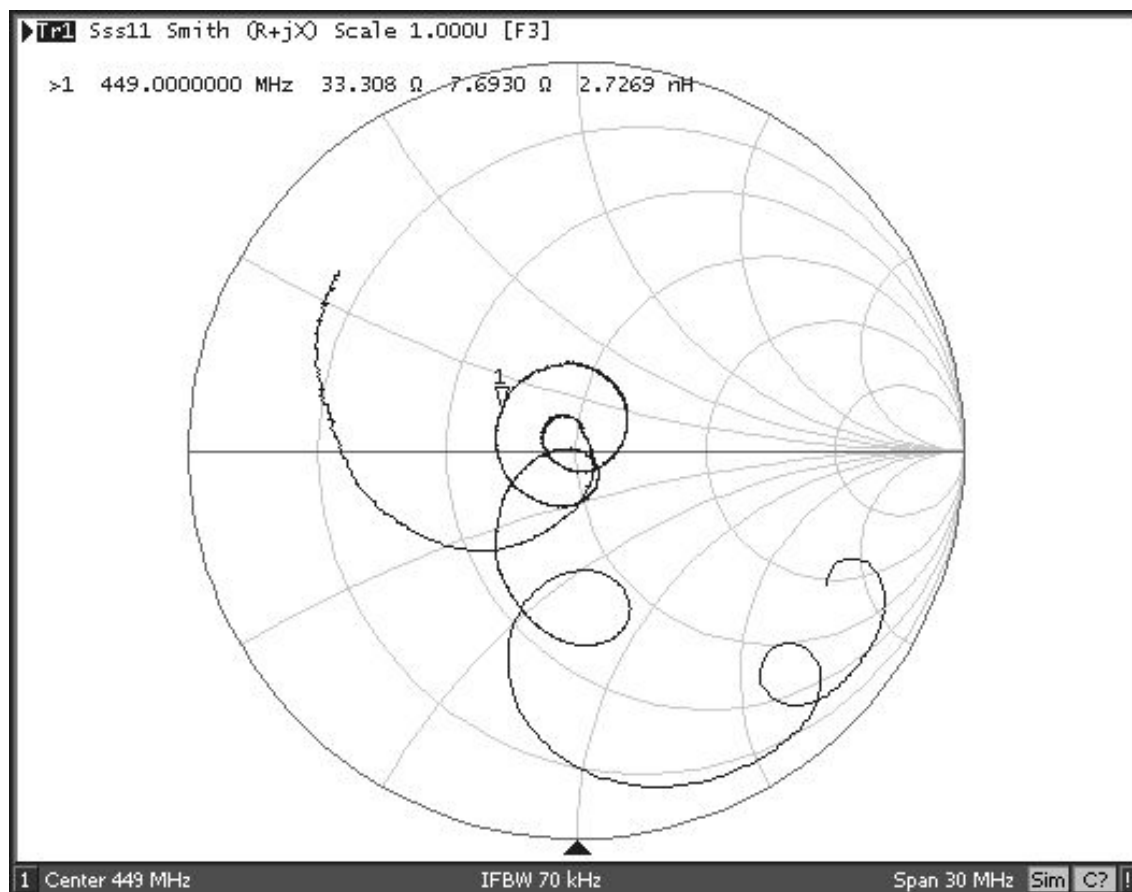
RF3609D Response, 399 to 499 MHz



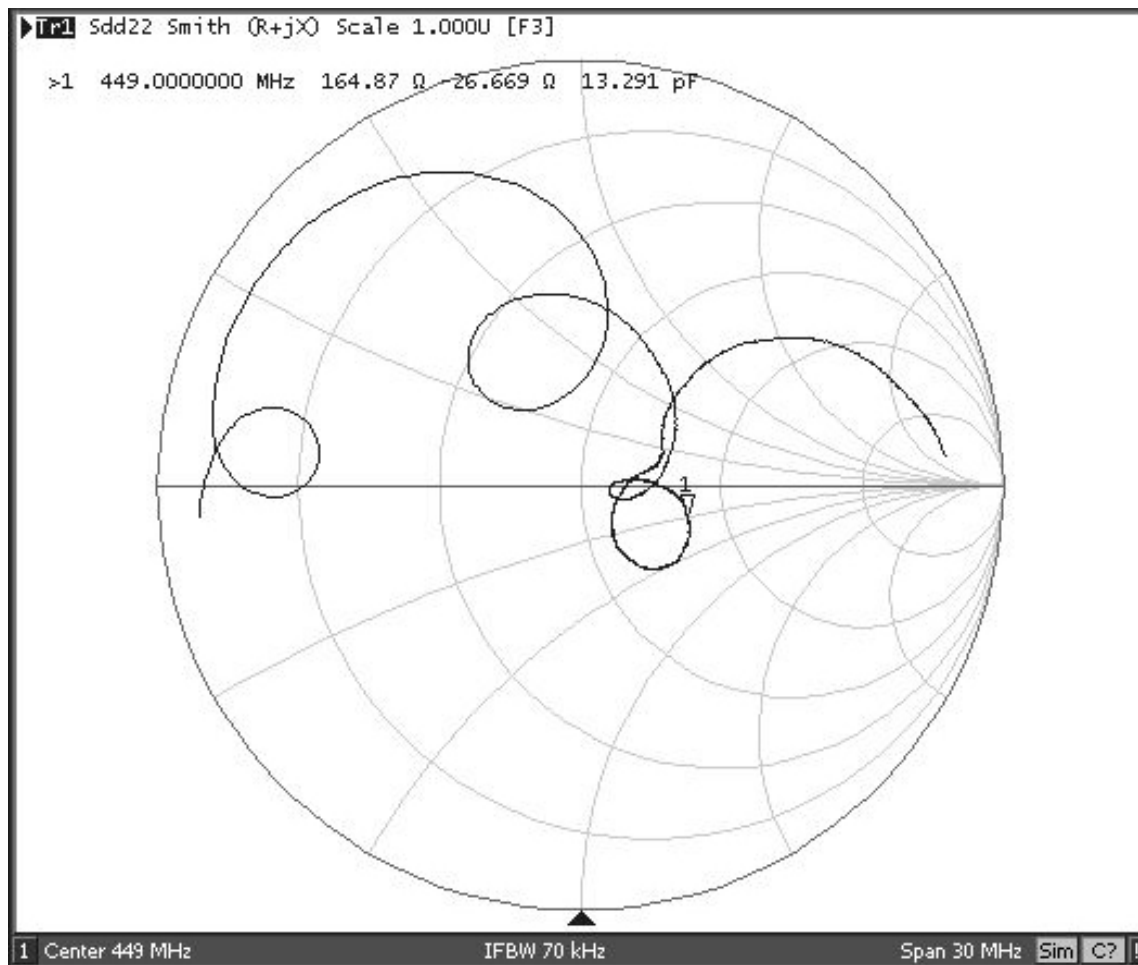
RF3609D Passband Response



RF3609D Input Impedance Plot

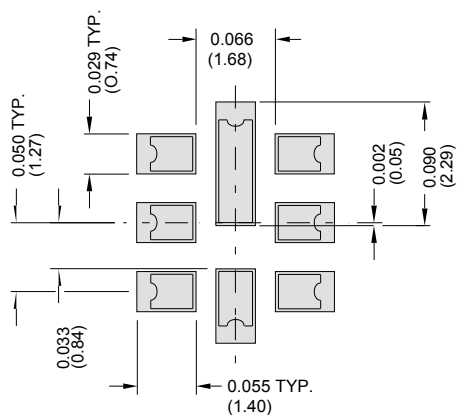


RF3609D Balanced Output Impedance Plot



8-Terminal Ceramic Surface-Mount Case

3.8 X 3.8 mm Nominal Footprint

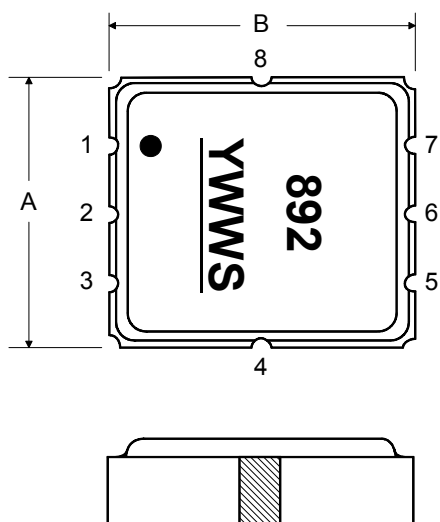


PCB Footprint

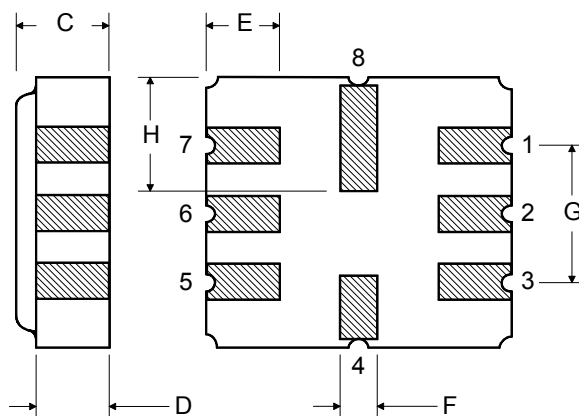
Dimension	mm			Inches		
	Min	Nom	Max	Min	Nom	Max
A	3.6	3.8	4.0	0.142	0.150	0.157
B	3.6	3.8	4.0	0.142	0.150	0.157
C	0.90	1.00	1.1	0.035	0.040	0.043
D	0.80	0.90	1.0	0.031	0.035	0.040
E	0.90	1.00	1.10	0.035	0.040	0.043
F	0.50	0.60	0.70	0.020	0.024	0.028
G	2.39	2.54	2.69	0.090	0.100	0.110
H	1.40	1.75	2.05	0.055	0.069	0.080

Materials	
Solder Pad Plating	0.3 to 1.0 μ m Gold over 1.27 to 8.89 μ m Nickel
Lid Plating	2.0 to 3.0 μ m Nickel
Body	Al ₂ O ₃ Ceramic

TOP VIEW



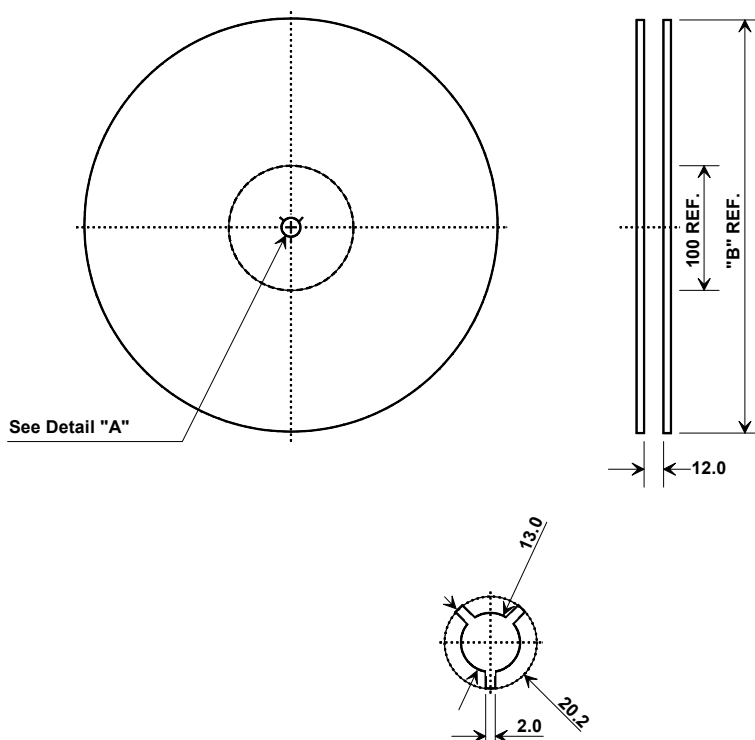
BOTTOM VIEW



Tape and Reel Specifications

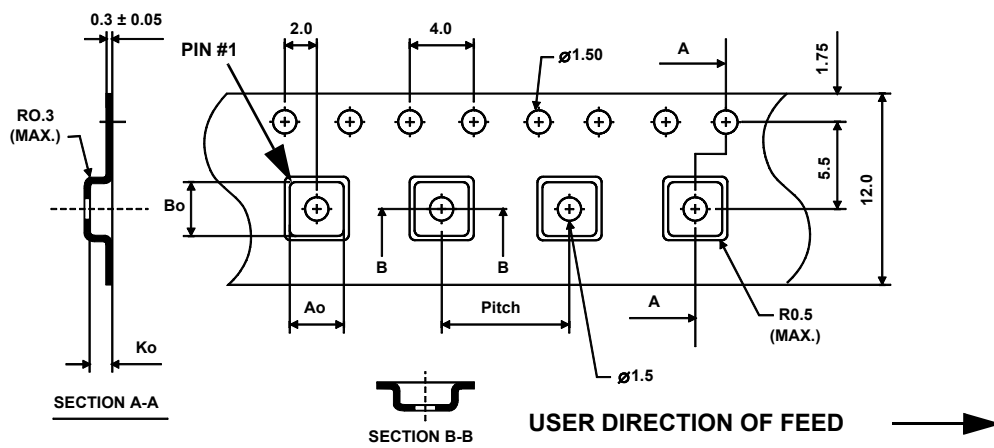
Tape and Reel Standard per ANSI/EIA-481

"B" "Nominal Size"		Quantity Per Reel
Inches	millimeters	
7	178	500
13	330	3000



COMPONENT ORIENTATION and DIMENSIONS

Carrier Tape Dimensions	
Ao	4.25 mm
Bo	4.25 mm
Ko	1.30 mm
Pitch	8.0 mm
W	12.0 mm



Recommended Reflow Profile

1. Preheating shall be fixed at 150~180°C for 60~90 seconds.
2. Ascending time to preheating temperature 150°C shall be 30 seconds min.
3. Heating shall be fixed at 220°C for 50~80 seconds and at 260°C +0/-5°C peak (10 seconds).
4. Time: 5 times maximum.

